

MSRTTA20060(A)(R) THRU MSRTTA200160(A)(R)

HIGH POWER DIODE MODULE TYPES 200A / 600-1600V

Features

High Surge Capability
Types up to 1600V V_{RRM}
Isolation Type Package
Electrically Isolation base plate

Maximum Ratings

Operating Temperature : -40°C to +175°C Storage Temperature : -40°C to +175°C

Part Number	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
MSRTTA20060(A)(R)	600V	420V	600V
MSRTTA20080(A)(R)	800V	560V	800V
MSRTTA200100(A)(R)	1000V	700V	1000V
MSRTTA200120(A)(R)	1200V	840V	1200V
MSRTTA200140(A)(R)	1400V	980V	1400V
MSRTTA200160(A)(R)	1600V	1120V	1600V

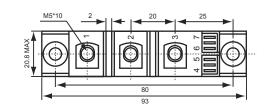
Electrical Characteristics @ 25 $^{\circ}$ C Unless Otherwise Specified

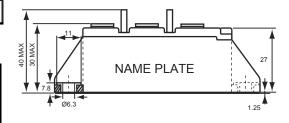
Average Forward Current (Per pkg)	lf(AV)	200A	Tc = 140°C
Peak Forward Surge Current (Per leg)	İFSM	2000A	8.3ms , half sine
Maximum (Per leg) Instantaneous Forward Voltage *	VF	1.10V	Іғм=100А;Т _Ј = 25°С
Maximum Instantaneous Reverse Current At Rated DC Blockig Voltage* (Per leg)	lr	10 <i>μ</i> A 5mA	T _J = 25°C T _J = 150°C
Isolation Voltage	Visol	2500V	A.C. 1minute
Maximum Thermal Resistance Junction To Case (Per leg)	Røjc	0.45°C/W	
Mounting torque		5 ± 0.5Nm 3 ± 0.5Nm	to heatsink to terminals

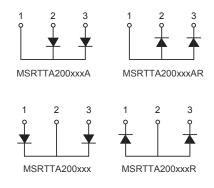
^{*}Pulse Test: Pulse Width 300 μ sec, Duty Cycle 2%



Dimensions in mm (1 mm = 0.0394")

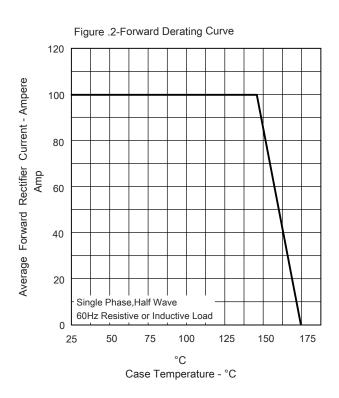


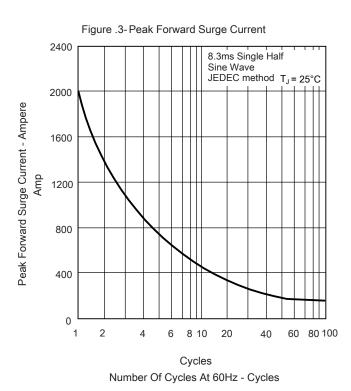


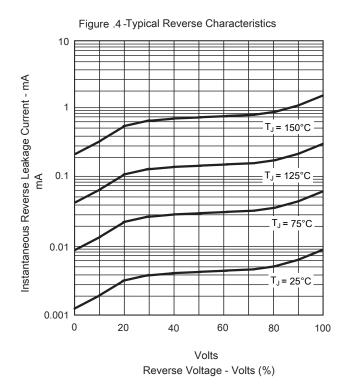


MSRTTA20060(A)(R) THRU MSRTTA200160(A)(R)

Figure .1- Typical Forward Characteristics 1000 nstantaneous Forward Current - Ampere 600 400 200 100 60 25°C 40 150°C 20 6 0.4 0.6 0.8 1.2 1.4 1.6 1.8 1.0 Volts Instantaneous Forward Voltage -Volts









MSRTTA20060(A)(R)

THRU

MSRTTA200160(A)(R)

Disclaimer

DACO Semiconductor reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein.

DACO Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does DACO Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Purchasers is responsible for its products and applications using DACO Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by DACO Semiconductor. "Typical" parameters which may be provided in DACO Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts.

DACO Semiconductor products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of DACO Semiconductor's product can reasonably be expected to result in personal injury, death or severe property or environmental damage. DACO Semiconductor accept no liability for inclusion and/or use of DACO Semiconductor's products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Purchasers buy or use DACO Semiconductor products for any such unintended or unauthorized application, Purchasers shall indemnify and hold DACO Semiconductor and its suppliers and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that DACO Semiconductor was negligent regarding the design or manufacture of the part.

No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of DACO Semiconductor Co., Ltd.